



CALL FOR EXHIBITION & SPONSORSHIP

Dear Valued Patrons,

The 2019 Asia-Pacific Microwave Conference (APMC) will be held in the beautiful Garden City of Singapore from December 10-13. APMC dates back to 1986 in New Delhi, and it is now recognized as one of the premier international conferences of microwave community. Singapore is proud to organize the 2019 APMC. This event will continue the spirit of APMC, address important issues in the microwave community to exchange results and discuss collaboration.

APMC 2019 will offer a rich scientific program of the highest quality with invited speakers from all over the world and provide a broad forum of exchange for both academia and industry alike. The 4-day conference program includes keynote speeches by distinguished speakers from industry, academia and government sectors, panels and forums, technical sessions featuring peer-reviewed technical papers, workshops focusing on the latest trends in various technologies, exhibitions, and a relaxing and entertaining banquet. The conference will cover the entire scope of active devices and circuits, passive components, communication systems, antennas and propagation, and other emerging areas.

Multiple levels of patronage and opportunities are designed to cater for the diversified needs of our potential patrons. As General Chair and Exhibition & Sponsorship Chair, we would like to invite you to become a patron of APMC 2019, which will provide you with one of the best opportunities to publicize your company and showcase your brand to the most influential engineering audience in microwave technologies, gain visibility and maximize the exposure of your products and services to industry leaders, influential researchers, operators, vendors, investors, and key decision makers.

For the first time, APMC 2019 will be launching the Startup Pavilion – an exhibition & networking area dedicated to our homegrown & overseas startups developing microwave-related tech-businesses. Based on the needs of growing technology enterprises all the way from seed to the growth stage, we will be planning several startup events as part of the APMC Conference & Exhibition.

You are welcome to visit our conference website at <https://apmc2019.org> for more information or contact our Exhibition & Sponsorship Chair **Dr. Terence See** at spsee@i2r.a-star.edu.sg.

We look forward to hearing from you, and seeing you at APMC 2019 in Singapore!

Prof. Arokiaswami Alphones
General Chair

Dr. Terence See
Exhibition & Sponsorship Chair

Patronage Package

	Platinum SGD 10,000	Gold SGD 7,500	Silver SGD 5,000	Bronze SGD 2,500	Supporter SGD 1,500
Exhibit Space	6 × 2 m	6 × 2 m	3 × 2 m	3 × 2 m	2 × 2 m
Full Complimentary Conference Registrations	4	3	2	1	-
Exhibit Passes	2	2	2	2	2
Company Logo (linked to company site) on Conference Website	√	√	√	√	√
Company Logo on all Conference Collaterals	√	√	√	√	√
Company information, Brochures/materials provided with the Conference Bag	√	√	√	√	√
Listing of Company, Products & Services on Conference Website	√	√	√	√	√
Full page Advertisement in Program Book	√ (Color)	√ (Color)	√ (B/W)	√ (B/W)	-
Opportunity to host an Industry-related Event	√	√	-	-	-

Startup Package

	Seed (SGD 1,000)	Launch (SGD 2,000)	Growth (SGD 4,000)
Exhibit Space (2 × 2 m)	√	√	√
Full Complimentary Conference Registrations	-	1	2
Exhibit Passes	2	2	2
Company information, Brochures/materials provided with the Conference Bag	√	√	√
Listing of Company, Products & Services on Conference Website	√	√	√
Full page Advertisement in Program Book	√ (B/W)	√ (B/W)	√ (Color)
Invitation to Present at Startup Talks	√*	√	√
Startup 101 Panel Discussion	√*	√	√

* subject to availability

Choice of Package: _____ Date: _____

Company Name: _____

Company Address: _____

Contact Name: _____ Designation: _____

Telephone: _____ Mobile Phone: _____ Fax: _____

Email: _____

Signature: _____ Company Stamp: _____

Payment Method (please choose ONE): Cheque/Internet Banking/Telegraphic Transfer

Payment Information:

Cheque Payment: Cheques to be crossed and payable to “IEEE APMC 2019”. Please indicate the conference name “IEEE APMC 2019” and Registrant’s Name at the back of the cheque. The cheque can be mailed to “Ace:Daytons Direct (International) Pte Ltd” Address: 2 Leng Kee Road #04-01 The Hong Centre, Singapore 159086 (Attn: 2019 APMC Secretariat).

Internet Banking/Telegraphic Transfer Payment: Please indicate the beneficiary name “IEEE APMC 2019” in your bank document. Amount must be nett of all bank charges.

Bank Name: Oversea-Chinese Banking Corporation Limited

Account Number: 713-098499-001

Swift Code: OCBCSGSG

Address: 65 Chulia Street, OCBC Centre, Singapore 049513

For general enquiries, please contact:

Conference Secretariat: +65 6379 5260 (Andre Chia/Stella Chee/Shi Hui)

Email: apmc2019singapore@gmail.com

For Patronage Package & Exhibition enquiries, please contact:

Dr. Terence See: +65 6408 2377

Email: spsee@i2r.a-star.edu.sg

For Startup Package enquiries, please contact:

Dr. Kush Agarwal: +65 8139 7232

Email: agarwal.kush@u.nus.edu

Our packages are flexible and open to alternative suggestions for consideration.

All sponsorship amounts are nett.